### **The 11<sup>th</sup> SEMBA (3587)**

# **Dual-Output Regulating Rectifier with Automatic Digital Offset Compensation**

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## Introduction

The proposed regulating rectifier has the following characteristics

Dual outputs: 5V and 3.3V

- Stimulating voltage and analog circuit power supply
- oX/1X regulating with PSM control
- Provide regulated voltages for sub-circuits Automatic digital offset compensation(ADOC)

# **System Architecture**



- On-time compensation: deal with insufficient conduction time
- Off-time compensation: minimize reverse current



One gate cross-coupled NMOS pair MN1 and MN2

□ Two pair PMOS active diodes MH1, MH2 and ML1, ML<sub>2</sub> with the comparator control.

The resonant tank consists of  $L_{RX}$  and  $C_{RX}$  in series and it operates at 6.78-MHz

### **Simulation Results**

□Simulated waveform of dual-output voltages



#### **Characteristics**

Priority

RX\_mode = 1



By utilizing the PSM technique with hysteresis window, it can regulate desired output voltages.

 $\Box V_{\text{RECH}}$  has higher priority than  $V_{\text{RECL}}$ , if both  $V_{\text{RECH}}$  and V<sub>RECL</sub> are enough, system will enter oX mode.



The proposed dual-output regulated WPT system achieves 91.9% Rx and 79.6% system peak efficiency.





work realizes turn-on and turn-off offset compensation mechanism by comparing V<sub>REC</sub> and V<sub>AC</sub>. and controls the offset current automatically.

The compensation reaches an appropriate value through bit-by-bit calibration.

- 1. F.-B. Yang, J. Fuh, Y.-H. Li, M. Takamiya, and P.-H. Chen, "Structure-Reconfigurable" Power Amplifier (SR-PA) and 0X/1X Regulating Rectifier for Adaptive Power Control in Wireless Power Transfer System," IEEE J. Solid-State Circuits, vol. 56, no. 7, pp. 2054–2064, Jul. 2021.
- 2. F.-B. Yang, J. Fuh, and P.-H. Chen, "A 13.56MHz wireless power transfer system" with dual-output regulated active rectifier for implantable medical devices," in *Proc.* IEEE 61st Int. Midwest Symp. Circuits Syst. (MWSCAS), Aug. 2018, pp. 440–443.

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